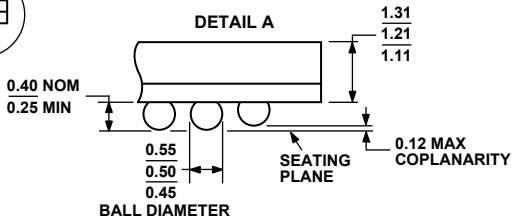
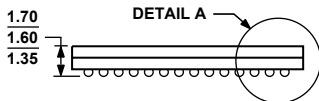
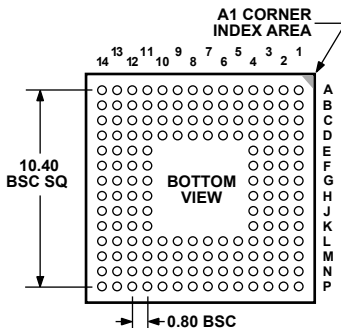
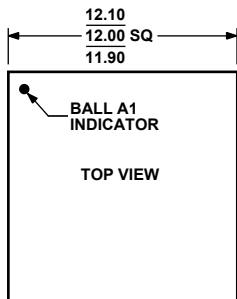


160-Lead Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-160-2)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-205-AE.